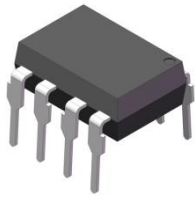
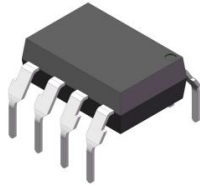


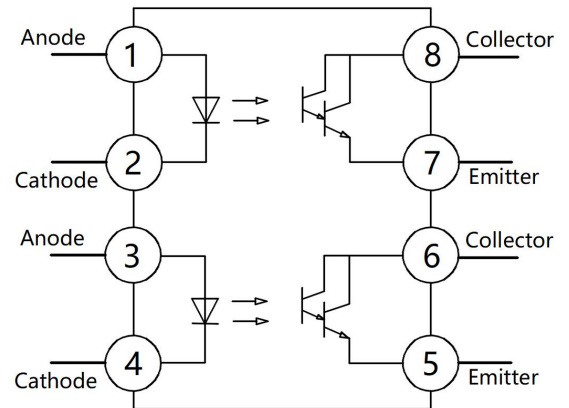
Product packaging logic diagram



DIP8



DIP8-M



Pin Configuration

Features

- Current transfer ratio
(CTR: 600~7500% at $I_F = 1\text{mA}$, $V_{CE} = 2\text{V}$)
- High isolation voltage between input and output ($V_{iso} = 5000\text{Vrms}$)
- Operating Temperature: $-55^\circ\text{C} \sim 110^\circ\text{C}$
- Environmentally friendly products, compliant with CQC, UL, and VDE requirements

Mechanical Data

- Case: DIP8、DIP8-M
- Molding Compound: UL Flammability Classification Rating 94V-0
- Terminals: Matte tin-plated leads; solder ability-per MIL-STD-202, Method 208

Applications

- It is widely used in the feedback control loops of switching power supplies and the isolation between main circuits and control circuits, ensuring stable output voltage and quickly transmitting fault signals to trigger protection mechanisms in the event of overload or short circuit.
- Photovoltaic energy storage system
- Data collection, inverter control, protection circuit
- Industrial automation control
- Relay drive, motor control, PLC interface
- Power management
- Switching power supply feedback isolation、 Home appliance power control



Ordering Information

XL 825 (X) (X) (X) - (U) (N) (Y)
 ① ② ③ ④ ⑤ ⑥ ⑦ ⑧

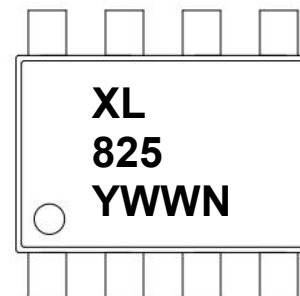
- ① Brand (XL)
- ② Product series (825)
- ③ Package type (None: (DIP8、DIP8-M、SMD8)
- ④ Halogen option (None :Halogen free)
- ⑤ CTR Bank (None: 600~7500%)
- ⑥ Lead frame (None: Copper)
- ⑦ Customer option 1 (0-9 or A- Z or none)
- ⑧ Customer option 2 (0-9 or A- Z or none)

Part Number	Package	Shipping Quantity	Marking Code
XL825	DIP8	45pcs / Tube	XL825
XL825M	DIP8-M	45pcs / Tube	XL825
XL825S	SMD8	1000pcs / Tape & Reel	XL825

Notes 1: X denotes CTR Rank : A, B or None.

Marking Information

- " XL" denotes brand.
- " 825" denotes Product series
- " Y" denotes Year : A(2024), B(2025), C(2026)
- " WW" denotes Week' s number .
- " N" denotes the day of Week.



Maximum Ratings (@ T_A = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit
Input	Forward Current	I _F	60	mA
	Reverse Voltage	V _R	6	V
	Peak Forward Current *1	I _{FP}	1	A
	Power Dissipation	P _D	100	mW
	Power dissipation Derating factor (above T _a = 100°C)	P _{DD}	5.8	mW/°C
	Thermal Resistance Junction-Ambient	R _{thJA}	325	°C/W
	Thermal Resistance Junction-Case	R _{thJC}	200	°C/W
Output	Collector Power Dissipation	P _C	150	mW
	Collector Current	I _C	80	mA
	Collector-Emitter Voltage	V _{CEO}	40	V
	Emitter-Collector Voltage	V _{ECO}	7	V

Thermal Characteristics

Parameter	Symbol	Value	Unit
Total Power Dissipation	PTOT	200	mW
Isolation Voltage *1	VISO	5000	V _{rms}
Operating Temperature	TOPR	-55 ~ +100	°C
Storage Temperature Range	TSTG	-55 ~ +125	°C
Soldering Temperature *2	TSOL	260	°C

Notes:

1. Pulse width ≤ 1μs, Duty ratio: 0.001
2. 40 to 60% RH, AC for 1 minute
3. For 10 seconds

Electrical Characteristics (@ T_A = 25°C unless otherwise specified)

Parameter		Symbol	Test Condition	Min.	Typ.	Max.	Unit
Input	Forward Voltage	V _F	I _F = 20mA	-	1.2	1.4	V
	Reverse Current	I _R	V _R = 4V	-	-	10	μA
	Terminal Capacitance	C _t	V _R = 0V, f = 1kHz	-	30	250	pF
Output	Collector-Emitter Dark Current	I _{CEO}	V _{CE} = 10V	-	-	1000	nA
	Collector-Emitter Breakdown Voltage	BV _{CEO}	I _C = 0.1mA, I _F = 0	40	-	-	V
	Emitter-Collector Breakdown Voltage	BV _{ECO}	I _E = 10μA, I _F = 0	7	-	-	V
Transfer Characteristics	Current Transfer Ratio	CTR	I _F = 1 mA, V _{CE} = 2V	600	-	7500	%
	Collector-Emitter Saturation Voltage	V _{CE(sat)}	I _F = 20mA, I _C = 5mA	-	0.8	1	V
	Isolation Resistance	R _{ISO}	V _{IO} = 500Vdc 40~60% R.H.	5×10 ¹⁰	-	-	Ω
	Isolation Capacitor	C _f	V _{IO} = 0, f = 1MHz	-	0.6	1.0	pF
	Cut-off frequency	f _c	V _{CE} = 5V, I _C = 2mA R _L =100Ω, -3dB	-	6	-	kHz
	Turn on Time	T _{on}	V _{CE} =2V, R _L = 100Ω	-	60	300	μs
	Turn off Time	T _{off}	I _C =10mA	-	53	250	

Ratings and Characteristics Curves (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Fig.1 Current Transfer Ratio vs. Forward Current

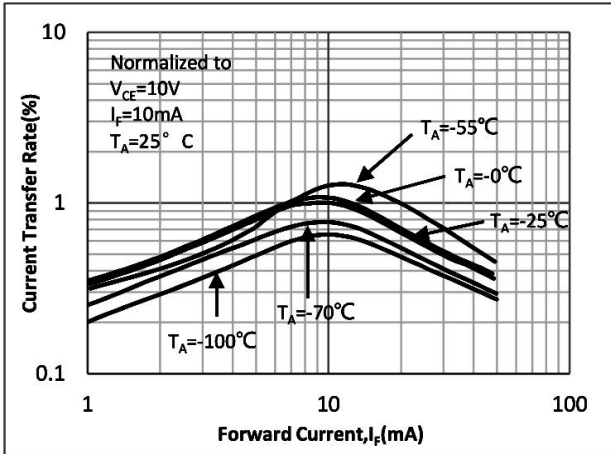


Fig.2 Forward Current vs. Forward Voltage

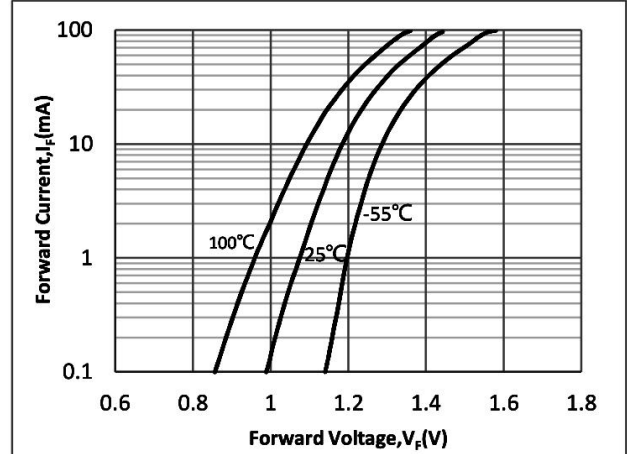


Fig.3 Turn On Time vs. Forward Current

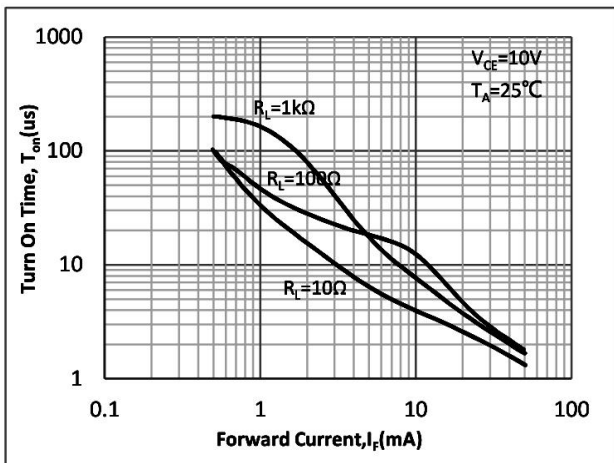


Fig.4 Relative Current Transfer Ratio vs. Ambient Temperature

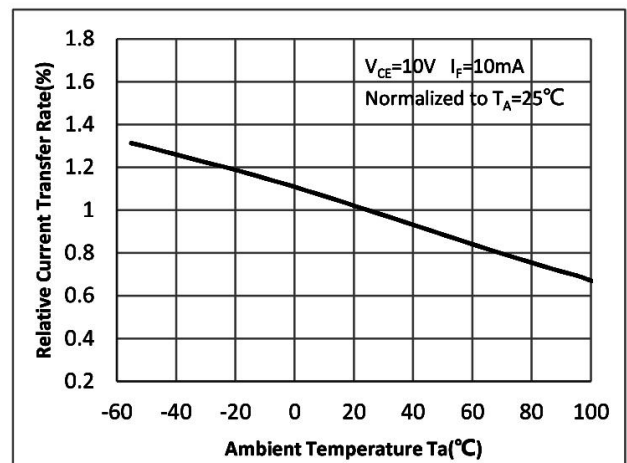


Fig.5 Turn Off Time vs. Forward Current

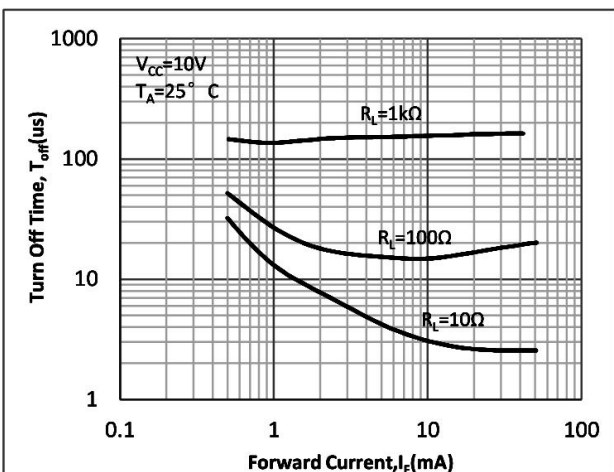
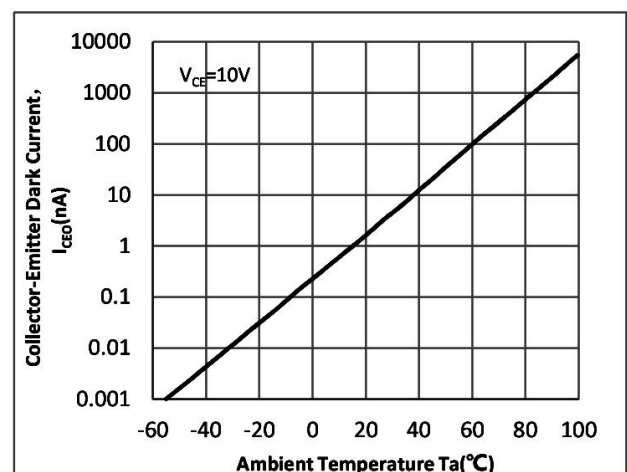
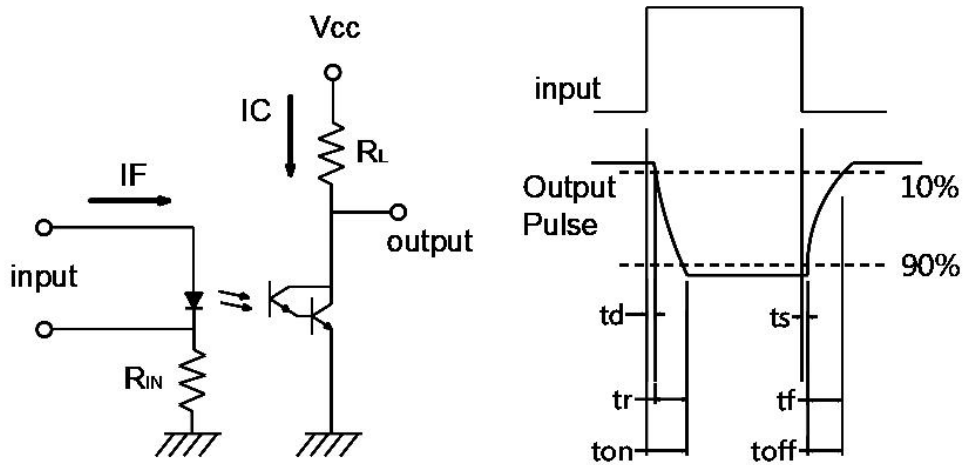


Fig.6 Collector-Emitter Dark Current vs. Ambient Temperature



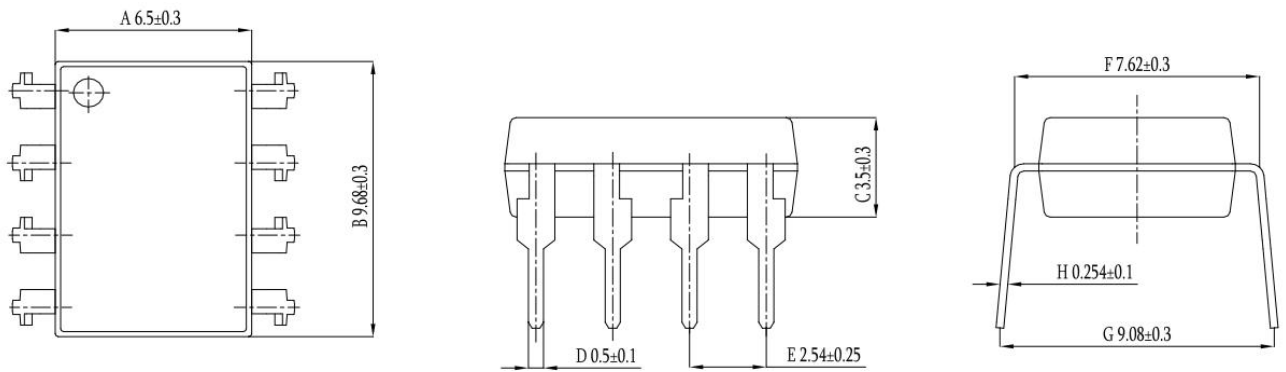
Ratings and Characteristics Curves (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Fig.7 witching Time Test Circuit & Wave forms

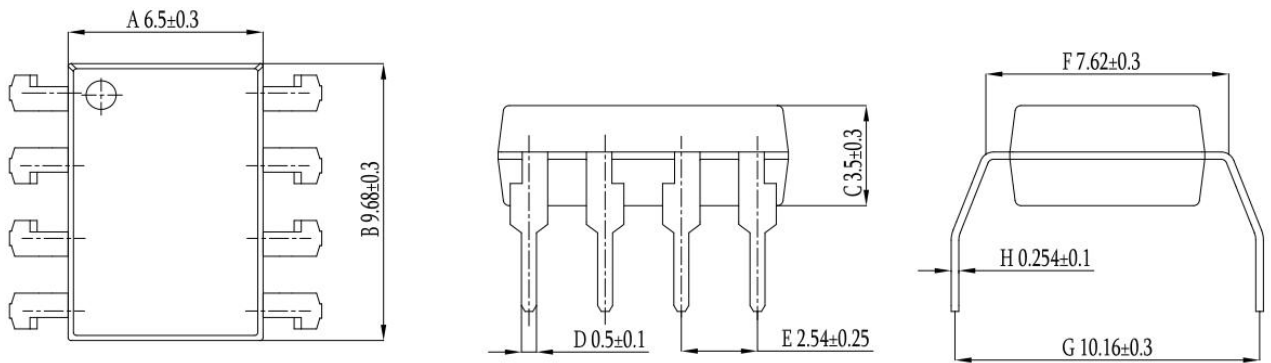


Package Outline Dimensions (unit: mm)

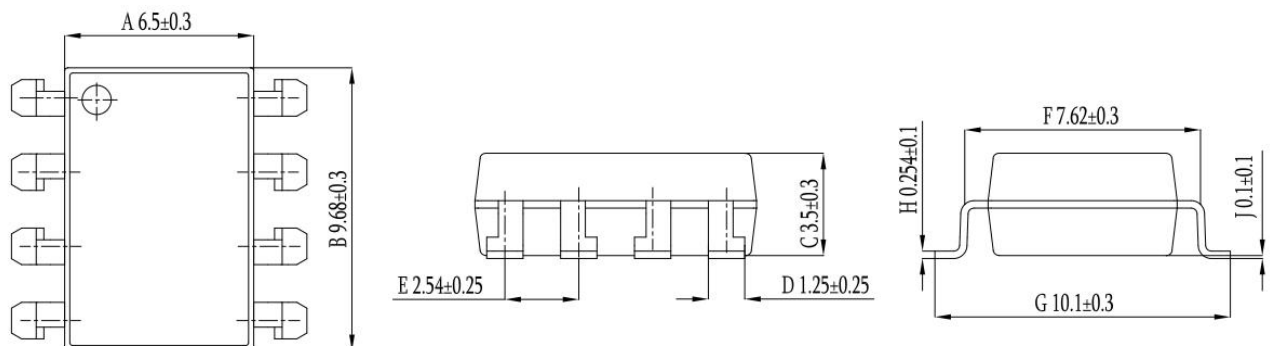
DIP8



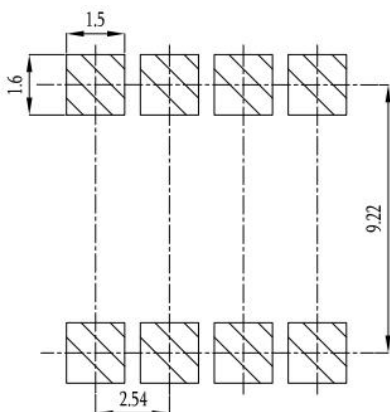
DIP8-M



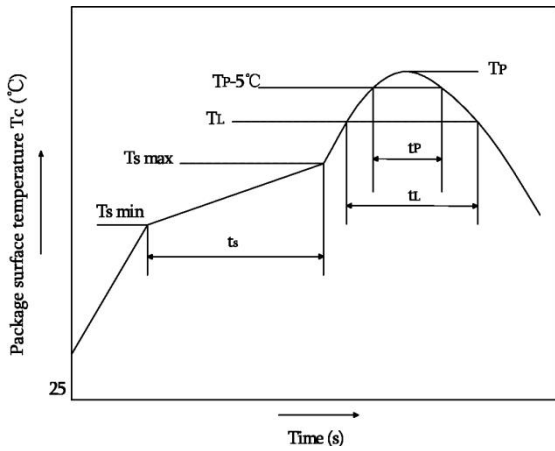
SMD8



SOLDERING FOOTPRINT (unit: mm)



Reflow soldering

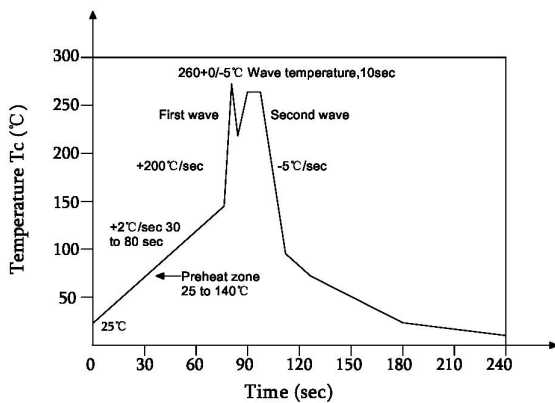


	Symbol	Min	Max	Unit
Preheat temperature	Ts	150	200	°C
Preheat time	ts	60	120	s
Ramp-up rate(T _L to T _P)			3	°C/s
Liquidus temperature	T _L	217		°C
Time above T _L	t _L	60	150	s
Peak temperature	T _P		260	°C
Time during which T _c is between (T _P -5) and T _P	t _p		30	s
Ramp-down rate(T _P to T _L)			6	°C/s

Note:

Reflow soldering is recommended at the temperatures and times shown, no more than three times.

Wave soldering



Profile feature	
Average ramp-up rate	~200°C/s
Heating rate during preheat	1°C/s to 2°C/s typical; 4°C/s maximum
Final preheat temperature Ts	~130°C
Preheat time (25°C to Ts)	>60s
Peak temperature Tp	260°C
Time within peak temperature tp	10s
Ramp-down rate	5°C/s maximum

Soldering with hand soldering iron

- A. Hand soldering iron is only used for product rework or sample testing.
- B. Hand soldering iron requirements: Temperature: 360 °C+5°C within 3s.

Packing

Package Type	Packing Form	Quantity per Tube & Reel	Quantity per Box	Quantity per Carton	Antistatic Bag Specification	Box Specification	Carton Specification	Note
DIP8	Tube(500mm)	45pcs/tube	50 tubes /box	10 boxes /ctn	190*670mm	520*105*50mm	545*372*235mm	Straight insert type material tube
DIP8-M	Tube(500mm)	45pcs/tube	50 tubes /box	10 boxes /ctn	190*670mm	520*105*50mm	545*372*235mm	Seagull foot (M foot) tube
SMD-8	Reel(φ330mm)	1000pcs/reel	2 reels /box	5 boxes /ctn	380*420mm	350*340*60mm	365*330*370mm	Guard band 200mm /min.

■ Summary table

■ DI8/DIP8-M (Tube)

Qty/ tube: 45pcs. Qty/box: 2250pcs.

Qty/ctn: 22500pcs.

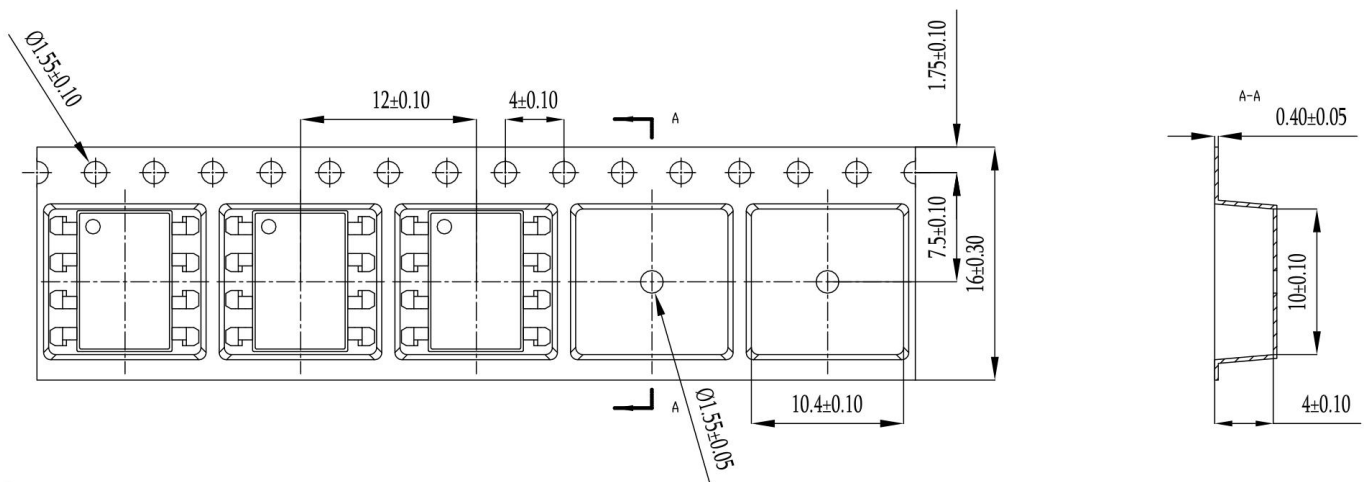
Schematic: (unit:mm)

■ SMD8 (Reel)

Qty/reel: 1000pcs. Qty/box: 2000pcs.

Qty/ctn: 10000pcs.

Schematic: (unit:mm)



Attention

- XINGLIGHT implements dynamic technical updates. Specifications are subject to change. Refer to the official website for the latest version.
- Users must strictly adhere to specified conditions. Failures caused by misuse (overload, high temperature, incompatible circuits) are excluded from warranty.
- Contact technical support for customized validation in critical applications (medical devices, industrial control).
- This document is valid until Dec 31, 2026. Updates will be notified on the official website.
- For further clarification on technical specifications or application solutions, please contact us through official channels.